

Engineering/Process Change Notice

ECN/PCN No.: 4121

For Manufacturer					
Product Description: PLASTIC SMD MEMS OSCILLATOR	Abracon Part Number	-	 □ Documentation only □ ECN □ EOL 	⊠ Series □ Part Number	
Affected Revision: N	New Revision: EC)L	Application:	□ Safety ⊠ Non-Safety	
Prior to Change: Active https://abracon.com/datasheets/Ecliptek/EMK12.pdf					
After Change: EOL					
Cause/Reason for Change: Discontinuation of manufacturing capability.					
	Chang	ge Plan			
Effective Date: 2/7/2022	Additional Remarks: N/A				
Change Declaration: N/A					
Issued Date: 2/7/2022	Issued By: Brooke Cushman Product Engineer		Issued Department: Engineering		
Approval: Thomas Culhane Engineering Director	Approval: Reuben Quintanilla Quality Director		Approval: Ying Huang Purchasing Director		
	For Abrace	on EOL only			
Last Time Buy (if applicable): 5/7/2022	Alternate Part Number / Part Series: ASVDV (7.0x5.0mm)				
Additional Approval:	Additional Approval:		Additional Approval:		
	Customer Appro	val (If Applicable)			
Qualification Status: Approved D Not accepted Note: It is considered approved if there is no feedback from the customer 1 month after ECN/PCN is released.					
Customer Part Number: Customer Project:					
Company Name:	Company Representative:		Representative Signature:		
Customer Remarks:					

Form #7020 | Rev. G | Effective: 02/22/2021 |

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Ecliptek









DRC





MEMS Clock Oscillators LVCMOS (CMOS) 2.5Vdc 4 Pad 5.0mm x 7.0mm Plastic Surface Mount (SMD)

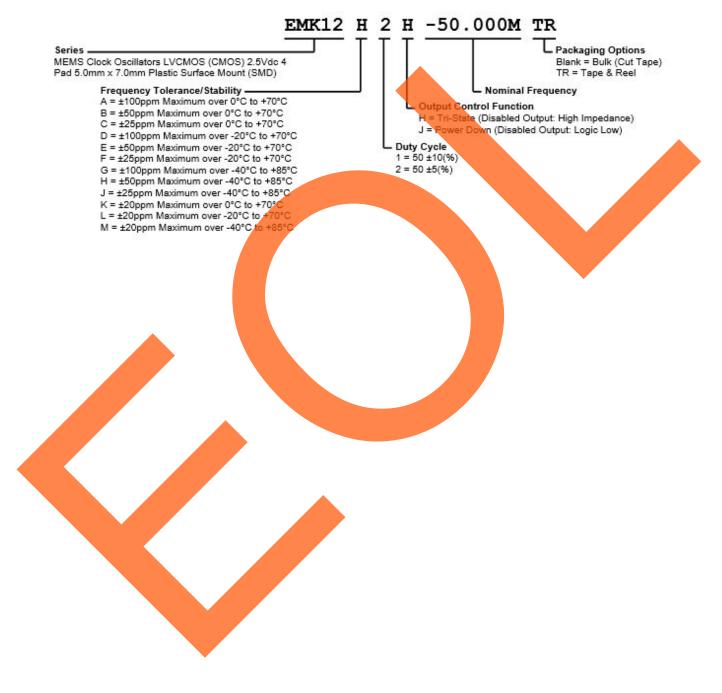
ELECTRICAL SPECIFICATIONS Nominal Frequency 1MHz to 125MHz Frequency Tolerance/Stability Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, First Year Aging at 25°C, 260°C Reflow, Shock, and Vibration

Frequency Tolerance/Stability	Supply Voltage Change, Output Load Change, First Year Aging at 25°C, 260°C Reflow, Shock, and Vibration
	±100ppm Maximum over 0°C to +70°C
	±50ppm Maximum over 0°C to +70°C
	±25ppm Maximum over 0°C to +70°C
	±100ppm Maximum over -20°C to +70°C
	±50ppm Maximum over -20°C to +70°C
	±25ppm Maximum over -20°C to +70°C
	±100ppm Maximum over -40°C to +76°C
	±50ppm Maximum over -40 °C to +85 °C
	±25ppm Maximum over -40°C to +85°C
	±20ppm Maximum over 0°C to +70°C
	±20ppm Maximum over -20°C to +70°C
	±20ppm Maximum over -40°C to +85°C
Aging at 25°C	±1ppm Maxim <mark>um Fir</mark> st Year
Supply Voltage	2.5Vdc ±5%
Input Current	No Load
	5mA Maximum over Nominal Frequency of 1MHz to 20MHz
	6mA Maximum over Nominal Frequency of 20.000001MHz to 50MHz
	7mA Maximum over Nominal Frequency of 50.000001MHz to 80MHz
	8mA Maximum over Nominal Frequency of 80.000001MHz to 125MHz
Output Voltage Logic High (V _{Oh})	IOH=-3mA
	90% of Vdd Minimum
Output Voltage Logic Low (Vol)	IOL=+3mA
	10% of Vdd Maximum
Rise/Fall Time	Measured from 20% to 80% of waveform
	1.2 <mark>nSec Typi</mark> cal, 3n Sec Maximum
Duty Cycle	Measured at 50% of waveform
	$50 \pm 10(\%)$
	50 ±5(%)
Load Drive Capability	15pF Maximum
Output Logic Type	CMOS
Output Control Function	Tri-State (Disabled Output: High Impedance)
Output Control Function	Power Down (Disabled Output: Logic Low)
Output Control Input Voltage	70% of Vdd Minimum or No Connect to Enable Output, 30% of Vdd Maximum to Disable Output
Deven Deven Output Enchie Time	50% of vdd Maximum to Disable Output
Power Down Output Enable Time	
Tri-State Output Enable Time	150nSec Maximum
Power Down Output Disable Time	150n <mark>Sec M</mark> aximum
Tri-State Output Disable Time	150nSec Maximum
Period Jitter (RMS)	2psec Typical, 4pSec Maximum
RMS Phase Jitter	0.5pSec Typical, 1pSec Maximum
(Fj = 900kHz to 7.5MHz; Random)	
RMS Phase Jitter	1.5pSec Typical, 3pSec Maximum
(Fj = 12kHz to 20MHz; Random)	
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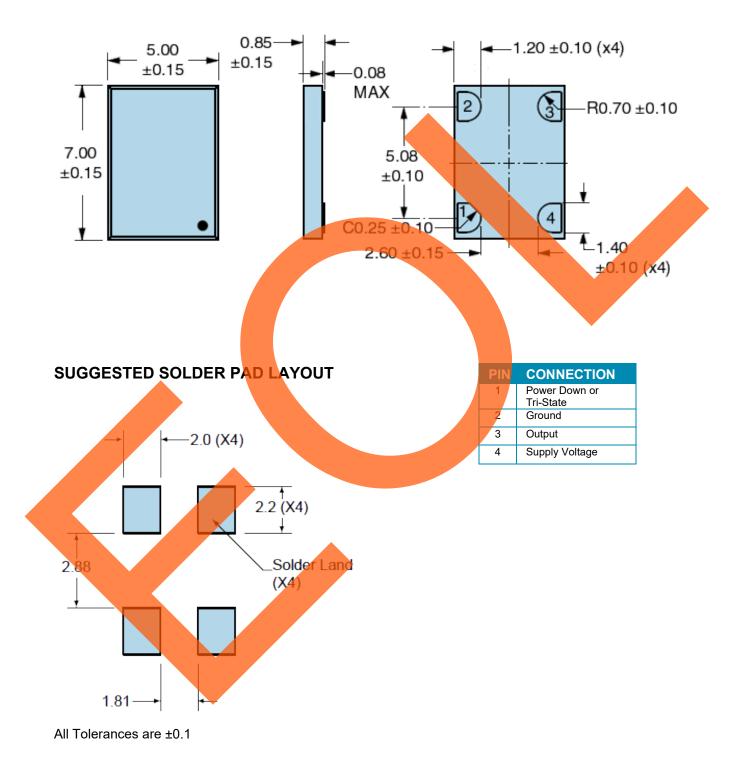
Standby Current	10µA Maximum (Disabled Output: Logic Low)	
Start Up Time	5mSec Maximum	
Storage Temperature Range	-65°C to +150°C	

PART NUMBERING GUIDE





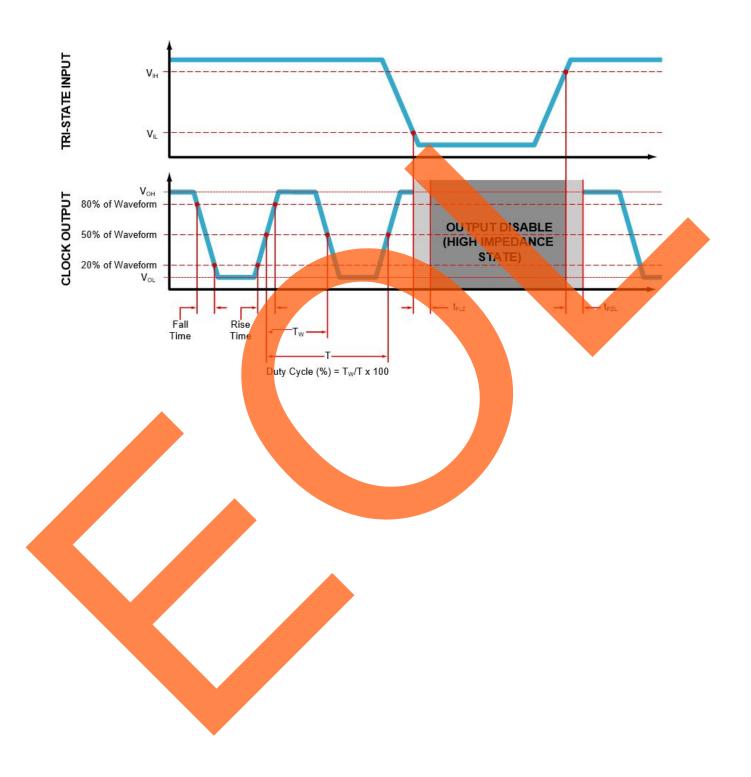
MECHANICAL DIMENSIONS



All Dimensions in Millimeters

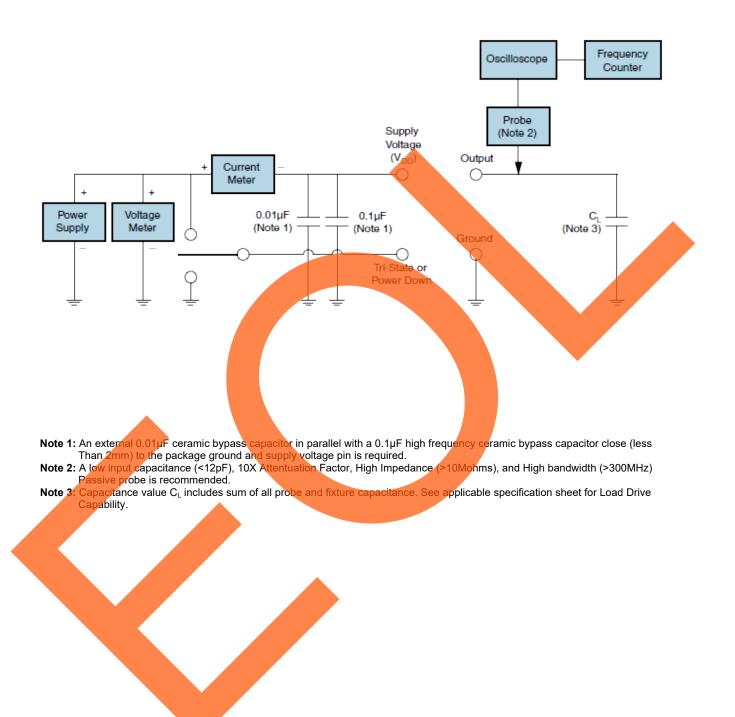


OUTPUT WAVEFORM & TIMING DIAGRAM





TEST CIRCUIT FOR CMOS OUTPUT

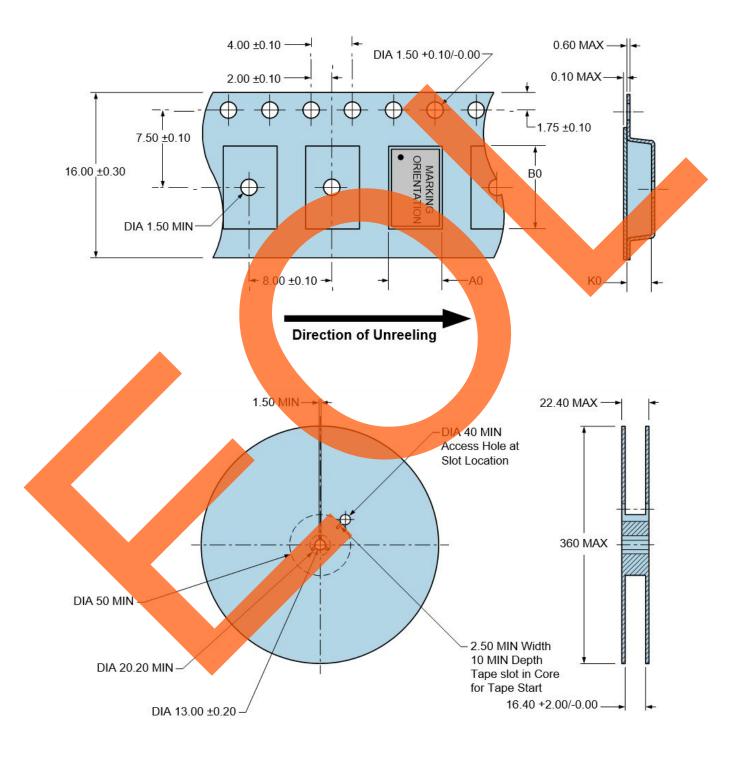




TAPE & REEL DIMENSIONS

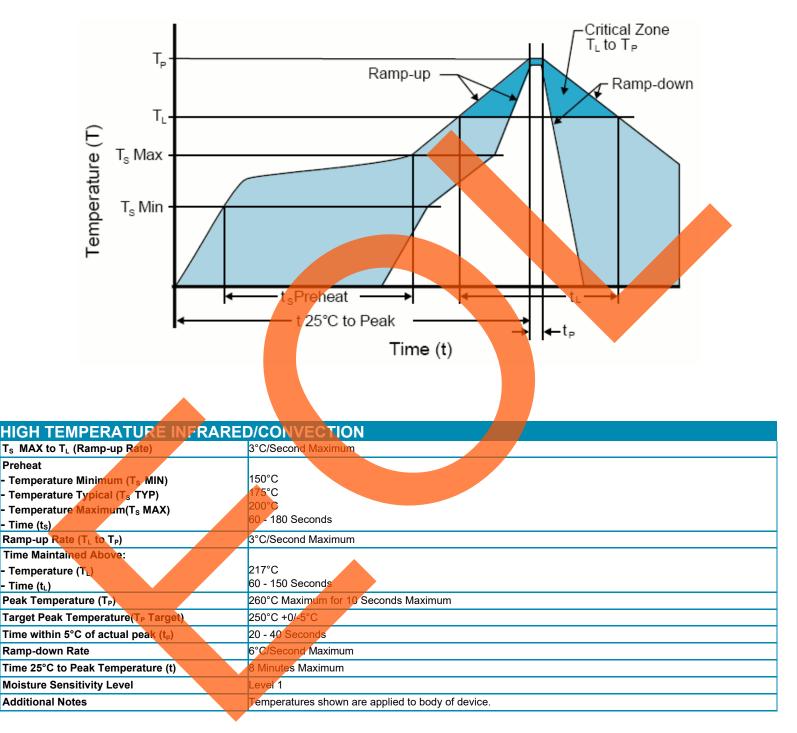
Quantity per Reel: 1,000 Units All Dimensions in Millimeters

Compliant to EIA-481





RECOMMENDED SOLDER REFLOW METHOD

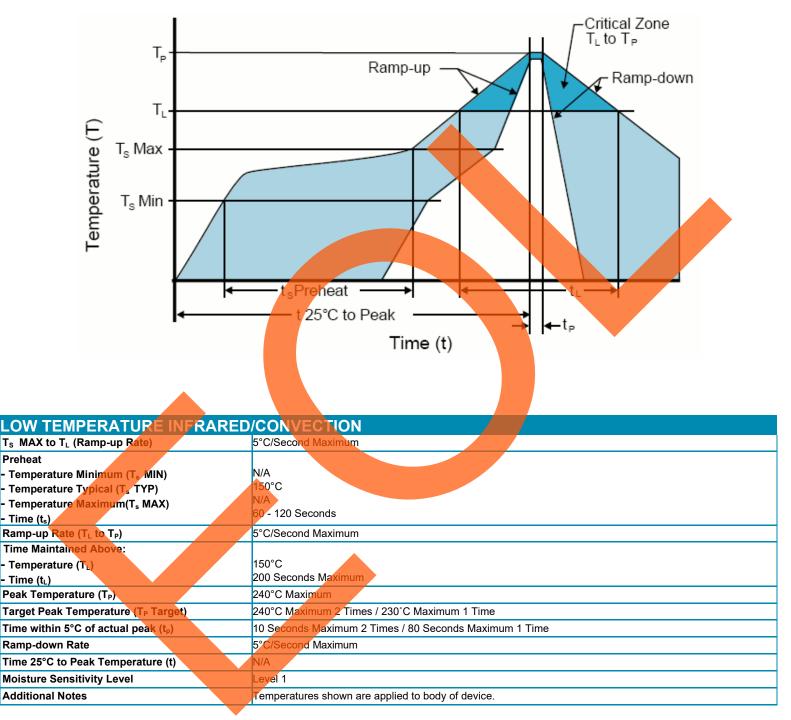


High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)



RECOMMENDED SOLDER REFLOW METHOD



Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)